

**Surface Mount Schottky Barrier Rectifier**  
**Reverse Voltage - 20 to 200 V**  
**Forward Current - 3 A**

**PINNING**

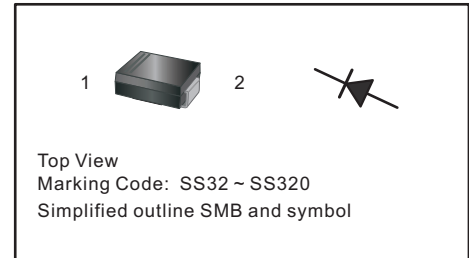
| PIN | DESCRIPTION |
|-----|-------------|
| 1   | Cathode     |
| 2   | Anode       |

**FEATURES**

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

**MECHANICAL DATA**

- Case: SMB
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 95mg ( 0.0034oz )

**Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

| Parameter                                                                                               | Symbols            | SS32B      | SS34B | SS36B | SS38B    | SS310B | SS312B | SS315B | SS320B | Units |
|---------------------------------------------------------------------------------------------------------|--------------------|------------|-------|-------|----------|--------|--------|--------|--------|-------|
| Maximum Repetitive Peak Reverse Voltage                                                                 | V <sub>RRM</sub>   | 20         | 40    | 60    | 80       | 100    | 120    | 150    | 200    | V     |
| Maximum RMS voltage                                                                                     | V <sub>RMS</sub>   | 14         | 28    | 42    | 56       | 70     | 84     | 105    | 140    | V     |
| Maximum DC Blocking Voltage                                                                             | V <sub>DC</sub>    | 20         | 40    | 60    | 80       | 100    | 120    | 150    | 200    | V     |
| Maximum Average Forward Rectified Current                                                               | I <sub>F(AV)</sub> | 3.0        |       |       |          |        |        |        |        | A     |
| Peak Forward Surge Current, 8.3ms<br>Single Half Sine-wave Superimposed<br>on Rated Load (JEDEC method) | I <sub>FSM</sub>   | 80         |       |       |          |        |        |        |        | A     |
| Max Instantaneous Forward Voltage at 3 A                                                                | V <sub>F</sub>     | 0.55       |       | 0.70  |          | 0.85   |        | 0.95   |        | V     |
| Maximum DC Reverse Current T <sub>a</sub> = 25°C<br>at Rated DC Reverse Voltage T <sub>a</sub> = 100°C  | I <sub>R</sub>     | 0.5<br>5   |       |       | 0.3<br>3 |        |        |        | mA     |       |
| Typical Junction Capacitance <sup>(1)</sup>                                                             | C <sub>j</sub>     | 450        |       |       | 400      |        |        |        | pF     |       |
| Typical Thermal Resistance <sup>(2)</sup>                                                               | R <sub>θJA</sub>   | 60         |       |       |          |        |        |        |        | °C/W  |
| Operating Junction Temperature Range                                                                    | T <sub>j</sub>     | -55 ~ +150 |       |       |          |        |        |        |        | °C    |
| Storage Temperature Range                                                                               | T <sub>stg</sub>   | -55 ~ +150 |       |       |          |        |        |        |        | °C    |

( 1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

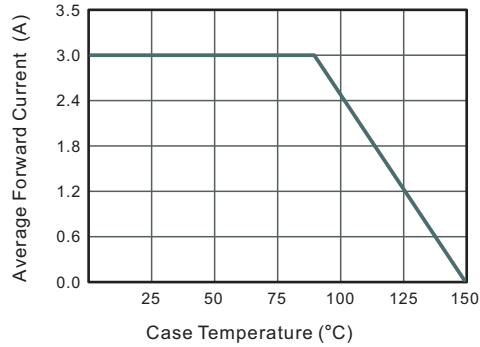


Fig.2 Typical Reverse Characteristics

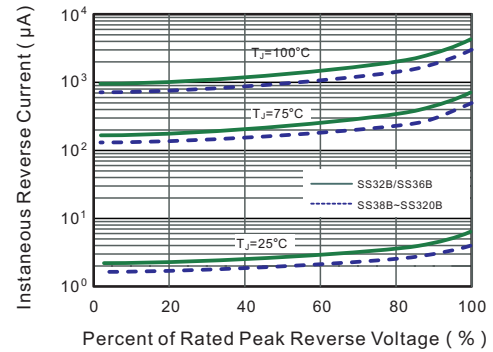


Fig.3 Typical Forward Characteristic

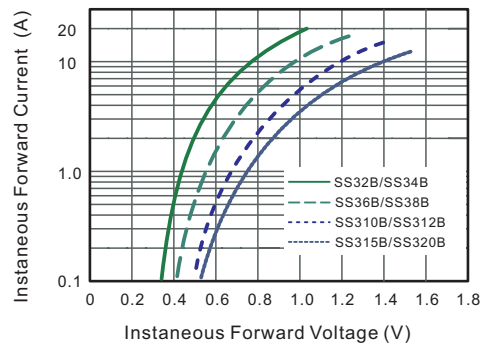


Fig.4 Typical Junction Capacitance

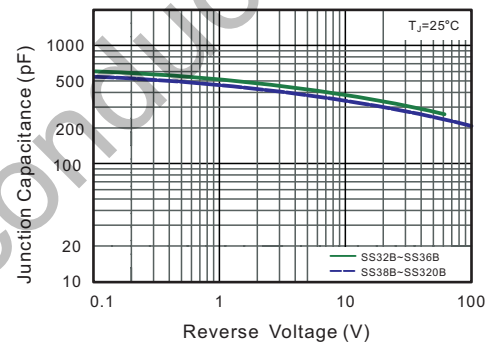


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

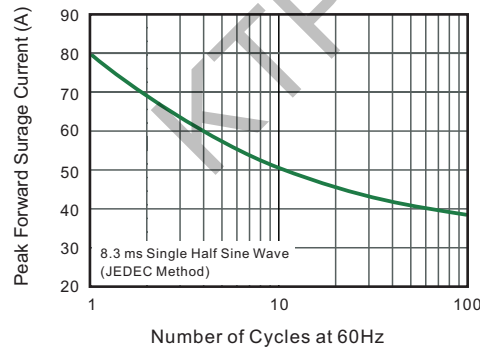
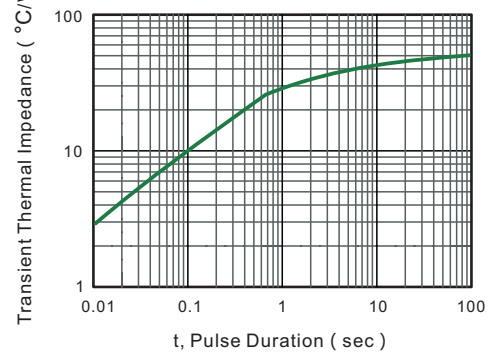


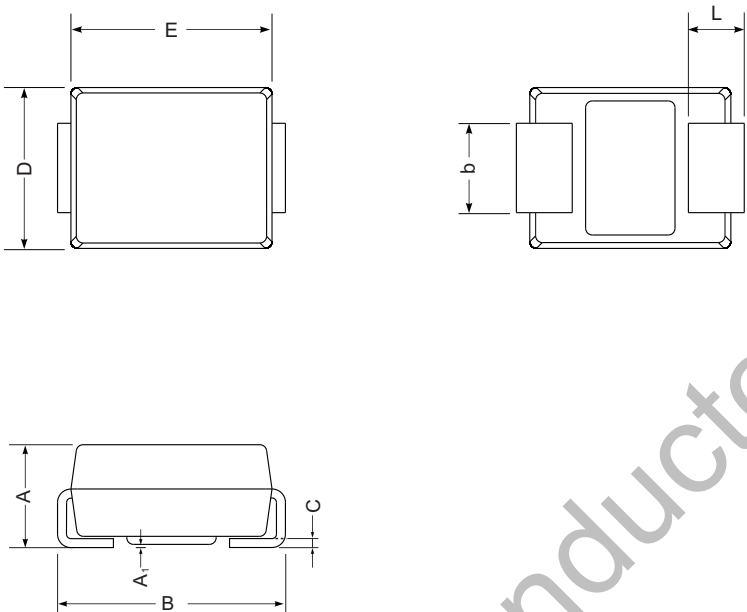
Fig.6- Typical Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

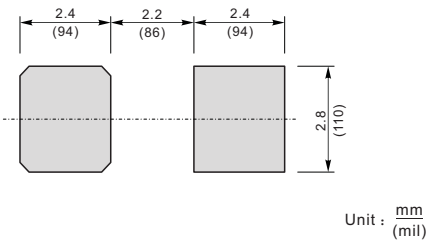
SMB



SMB mechanical data

| UNIT |     | A   | E    | D    | B   | A <sub>1</sub> | L   | C     | b   |
|------|-----|-----|------|------|-----|----------------|-----|-------|-----|
| mm   | max | 2.5 | 4.70 | 3.94 | 5.5 | 0.21           | 1.5 | 0.305 | 2.2 |
|      | min | 2.1 | 4.06 | 3.3  | 5.0 | 0.05           | 0.8 | 0.152 | 1.9 |
| mil  | max | 98  | 185  | 155  | 216 | 8.3            | 59  | 12    | 87  |
|      | min | 82  | 160  | 130  | 196 | 2.0            | 32  | 6     | 75  |

The recommended mounting pad size



Marking

| Type number | Marking code |
|-------------|--------------|
| SS32B       | SS32         |
| SS34B       | SS34         |
| SS36B       | SS36         |
| SS38B       | SS38         |
| SS310B      | SS310        |
| SS312B      | SS312        |
| SS315B      | SS315        |
| SS320B      | SS320        |